

Description

The HSP150N15 is the high cell density trenched N-ch MOSFETs, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

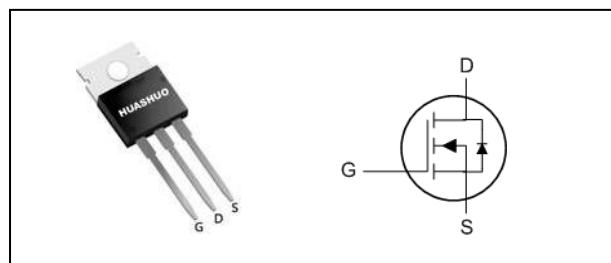
The HSP150N15 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

- 100% EAS Guaranteed
- Load Switch
- SR(Synchronous rectification)
- DC/DC Converter
- Advanced high cell density Trench technology

Product Summary

V _{DS}	150	V
R _{DS(ON),TYP}	5	mΩ
I _D	150	A

TO-220 Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	150	V
V _{GS}	Gate-Source Voltage	±20	V
I _D @T _c =25°C	Continuous Drain Current, V _{GS} @ 10V _{1,6}	150	A
I _D @T _c =100°C	Continuous Drain Current, V _{GS} @ 10V _{1,6}	95	A
I _{DM}	Pulsed Drain Current ²	600	A
EAS	Single Pulse Avalanche Energy ³	1350	mJ
P _D @T _c =25°C	Total Power Dissipation ⁴	310	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
R _{θJA}	Thermal Resistance Junction-Ambient ₁	---	62	°C/W
R _{θJC}	Thermal Resistance Junction-Case ₁	---	0.41	°C/W

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$\text{V}_{\text{GS}}=0\text{V}$, $\text{I}_D=250\mu\text{A}$	150	---	---	V
$\text{R}_{\text{DS(ON)}}$	Static Drain-Source On-Resistance ²	$\text{V}_{\text{GS}}=10\text{V}$, $\text{I}_D=30\text{A}$	---	5	6	$\text{m}\Omega$
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	$\text{V}_{\text{GS}}=\text{V}_{\text{DS}}$, $\text{I}_D=250\mu\text{A}$	2	3	4	V
I_{DSS}	Drain-Source Leakage Current	$\text{V}_{\text{DS}}=120\text{V}$, $\text{V}_{\text{GS}}=0\text{V}$, $T_J=25^\circ\text{C}$	---	---	1	μA
		$\text{V}_{\text{DS}}=120\text{V}$, $\text{V}_{\text{GS}}=0\text{V}$, $T_J=85^\circ\text{C}$	---	---	10	
I_{GSS}	Gate-Source Leakage Current	$\text{V}_{\text{GS}}=\pm 20\text{V}$, $\text{V}_{\text{DS}}=0\text{V}$	---	---	± 100	nA
g_{fs}	Forward Transconductance	$\text{V}_{\text{DS}}=10\text{V}$, $\text{I}_D=3\text{A}$	---	19	---	S
R_{g}	Gate Resistance	$\text{V}_{\text{DS}}=0\text{V}$, $\text{V}_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$	---	2.8	---	Ω
Q_{g}	Total Gate Charge (10V)	$\text{V}_{\text{DD}}=75\text{V}$, $\text{V}_{\text{GS}}=10\text{V}$, $\text{I}_D=80\text{A}$	---	120	---	nC
Q_{gs}	Gate-Source Charge		---	35	---	
Q_{gd}	Gate-Drain Charge		---	33	---	
$\text{T}_{\text{d(on)}}$	Turn-On Delay Time	$\text{V}_{\text{DD}}=75\text{V}$, $\text{V}_{\text{GS}}=10\text{V}$, $\text{R}_{\text{G}}=6\Omega$, $\text{I}_D=80\text{A}$	---	70	---	ns
T_{r}	Rise Time		---	200	---	
$\text{T}_{\text{d(off)}}$	Turn-Off Delay Time		---	440	---	
T_{f}	Fall Time		---	200	---	
C_{iss}	Input Capacitance	$\text{V}_{\text{DS}}=75\text{V}$, $\text{V}_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$	---	8600	---	pF
C_{oss}	Output Capacitance		---	700	---	
Crss	Reverse Transfer Capacitance		---	26	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_{s}	Continuous Source Current ^{1,5}	$\text{V}_{\text{G}}=\text{V}_{\text{D}}=0\text{V}$, Force Current	---	---	150	A
V_{SD}	Diode Forward Voltage ²	$\text{V}_{\text{GS}}=0\text{V}$, $\text{I}_{\text{s}}=50\text{A}$, $T_J=25^\circ\text{C}$	---	---	1	V
t_{rr}	Reverse Recovery Time	$\text{I}_{\text{F}}=20\text{A}$, $d\text{I}/dt=100\text{A}/\mu\text{s}$, $T_J=25^\circ\text{C}$	---	130	---	nS
Q_{rr}	Reverse Recovery Charge		---	720	---	nC

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. $\text{V}_{\text{DD}}=50\text{V}$, $\text{V}_{\text{GS}}=10\text{V}$, $\text{L}=1\text{mH}$, $\text{I}_{\text{AS}}=52\text{A}$, $\text{R}_{\text{G}}=25\Omega$, Starting $T_J=25^\circ\text{C}$.
3. The data tested by pulsed , pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
4. Essentially independent of operating temperature.

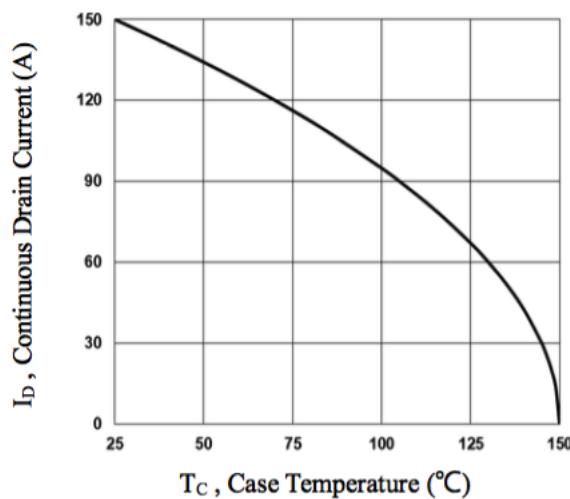


Fig.1 Continuous Drain Current vs. T_c

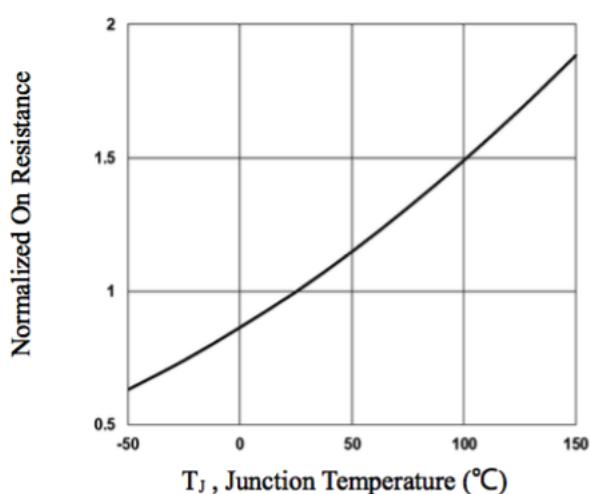


Fig.2 Normalized RD_{SON} vs. T_J

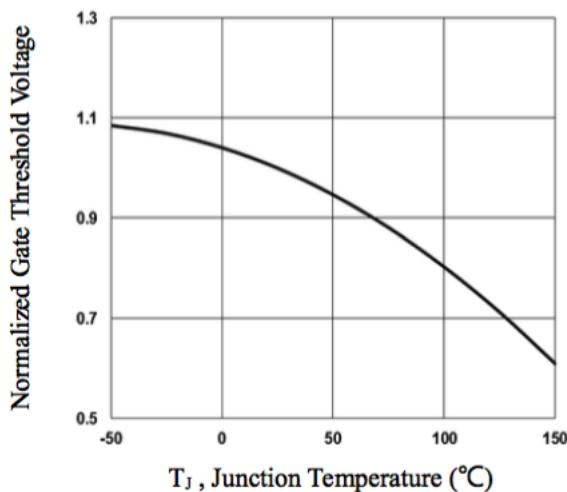


Fig.3 Normalized V_{th} vs. T_J

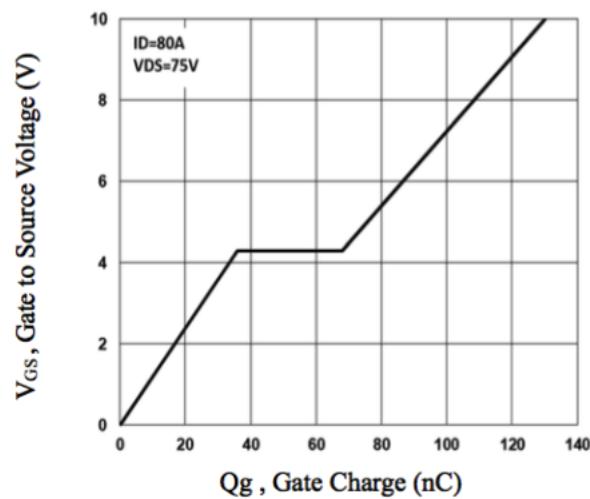


Fig.4 Gate Charge Characteristics

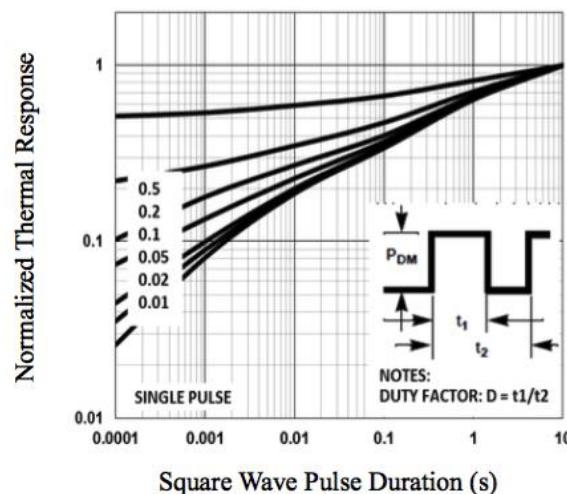


Fig.5 Normalized Transient Impedance

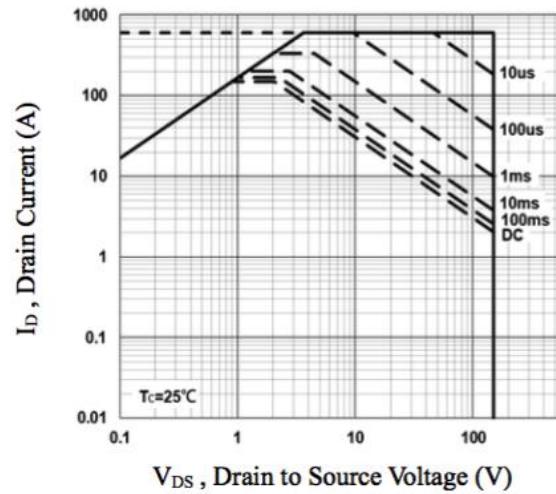


Fig.6 Maximum Safe Operation Area

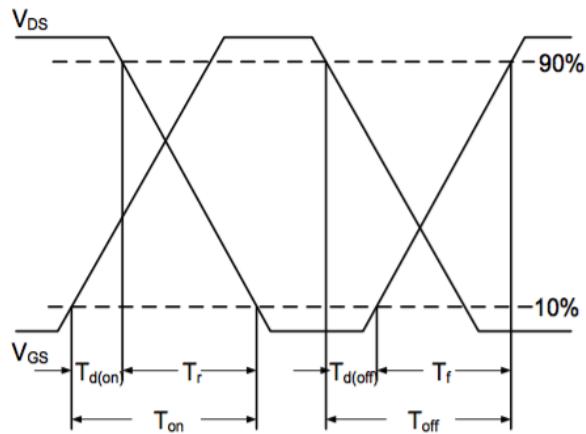


Fig.7 Switching Time Waveform

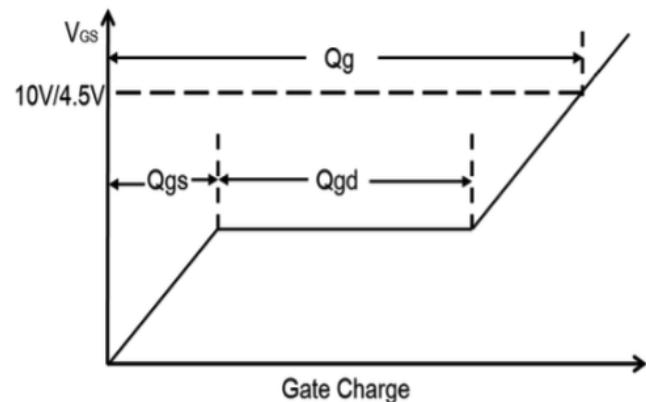
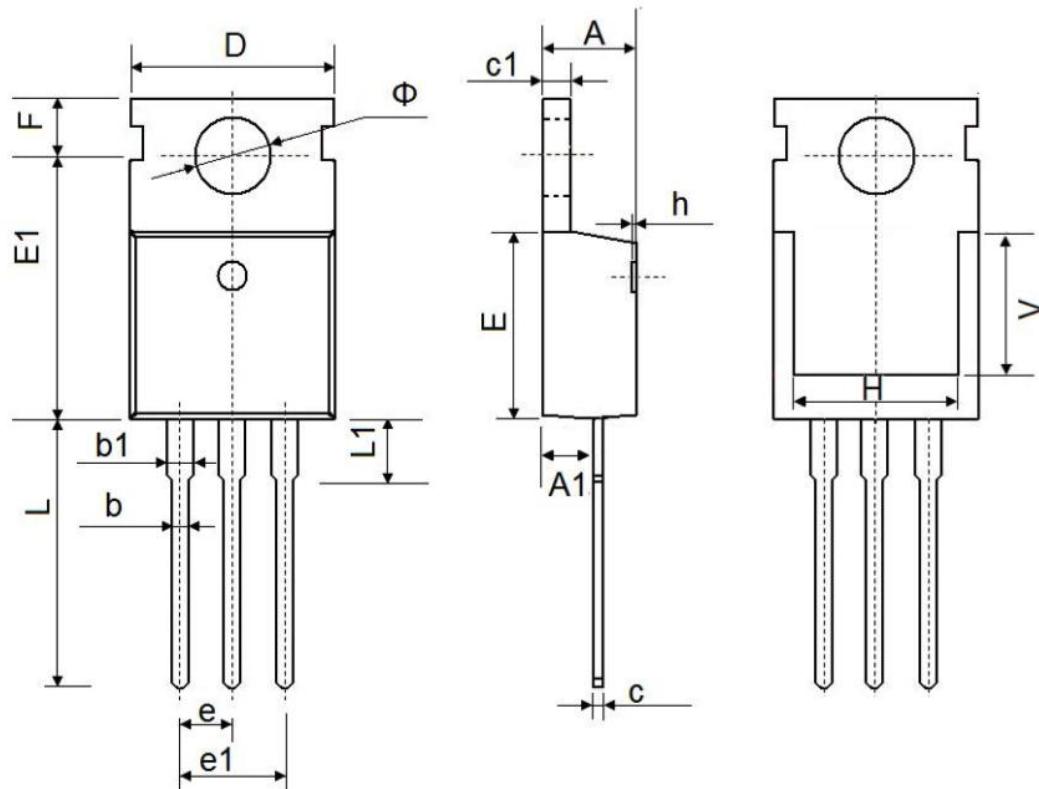


Fig.8 Gate Charge Waveform



TO-220 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max
A	4.300	4.700	0.169	0.185
A1	2.200	2.600	0.087	0.102
b	0.700	0.950	0.028	0.037
b1	1.170	1.410	0.046	0.056
c	0.450	0.650	0.018	0.026
c1	1.200	1.400	0.047	0.055
D	9.600	10.400	0.378	0.409
E	8.8500	9.750	0.348	0.384
E1	12.650	12.950	0.498	0.510
e	2.540 TYP.		0.100TYP.	
e1	4.980	5.180	0.196	0.204
F	2.650	2.950	0.104	0.116
H	7.900	8.100	0.311	0.319
h	0.000	0.300	0.000	0.012
L	12.750	14.300	0.502	0.563
L1	2.850	3.950	0.112	0.156
V	7.500 REF.		0.295 REF.	
Φ	3.400	4.000	0.134	0.157

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